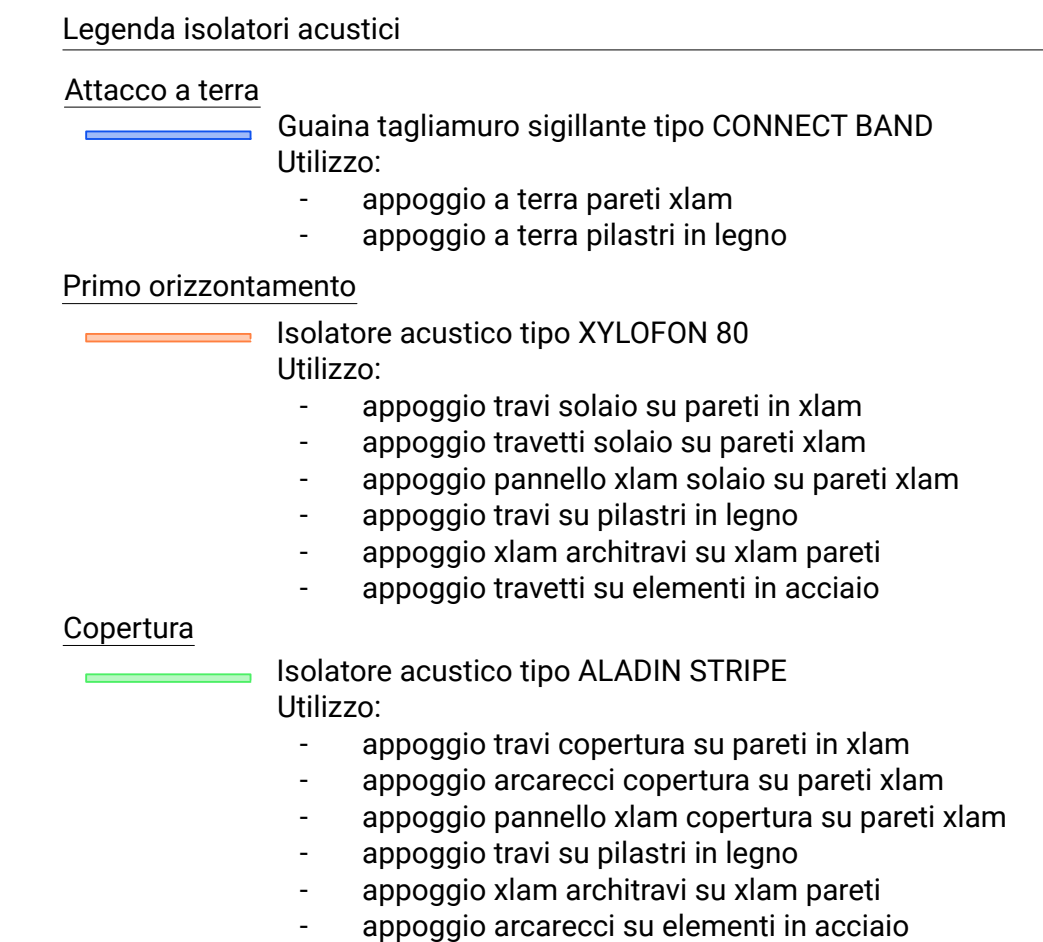
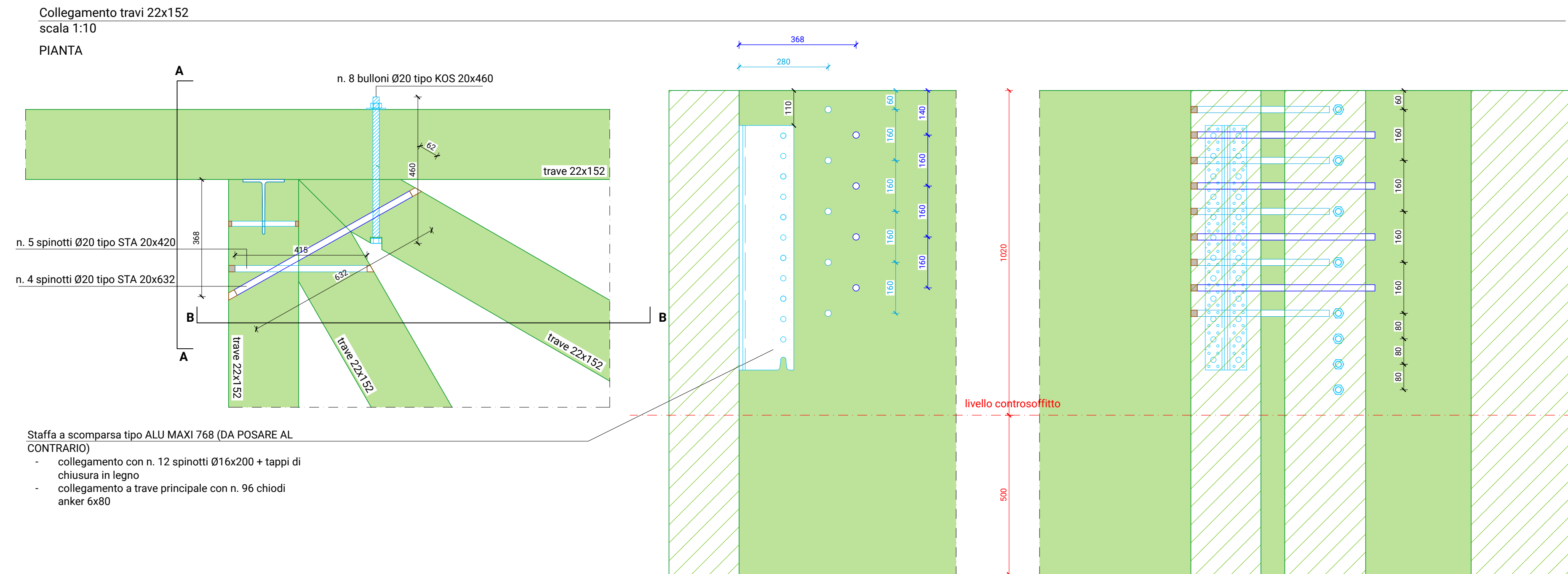
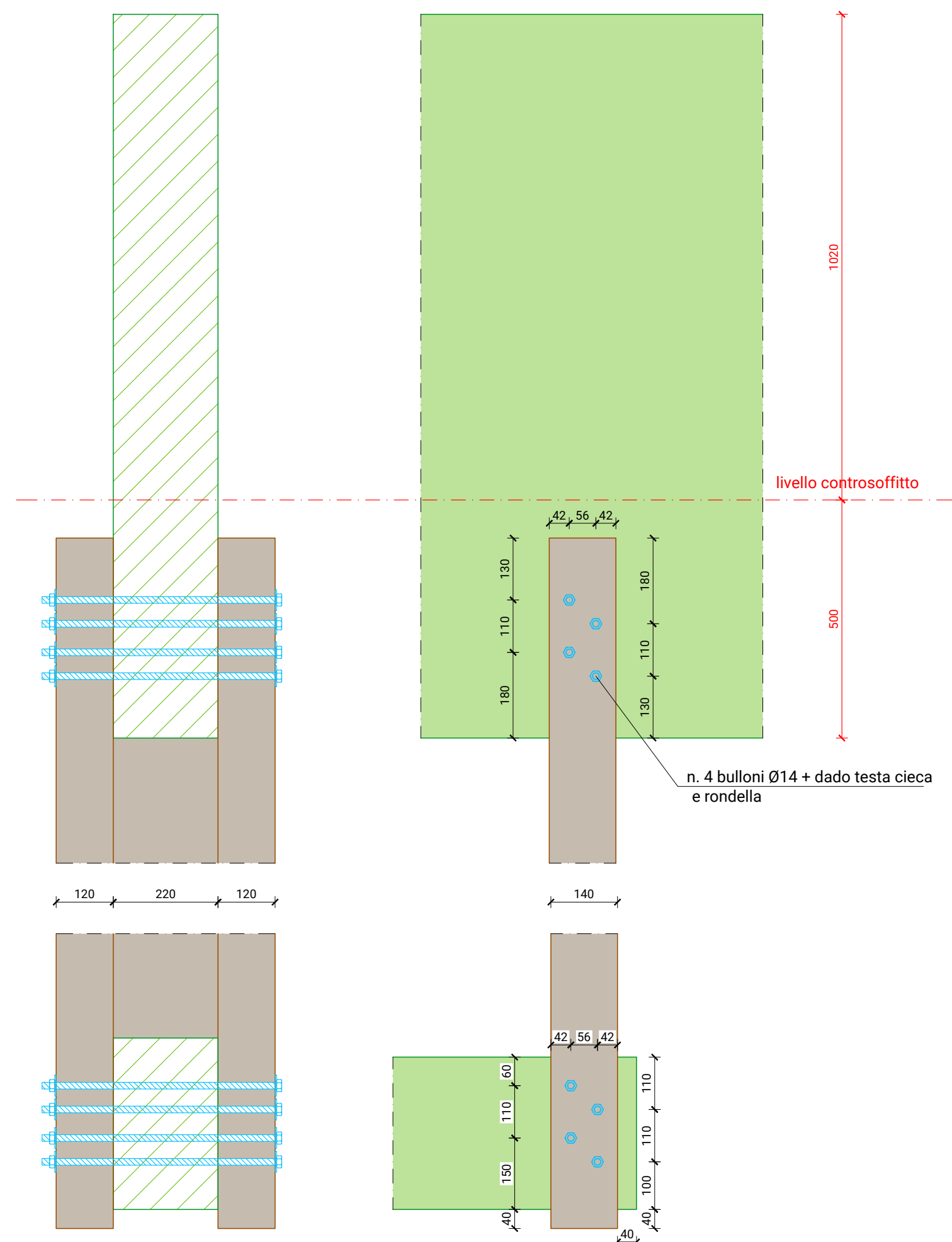
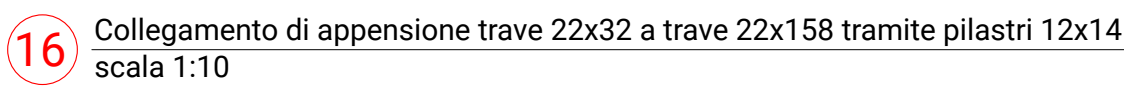
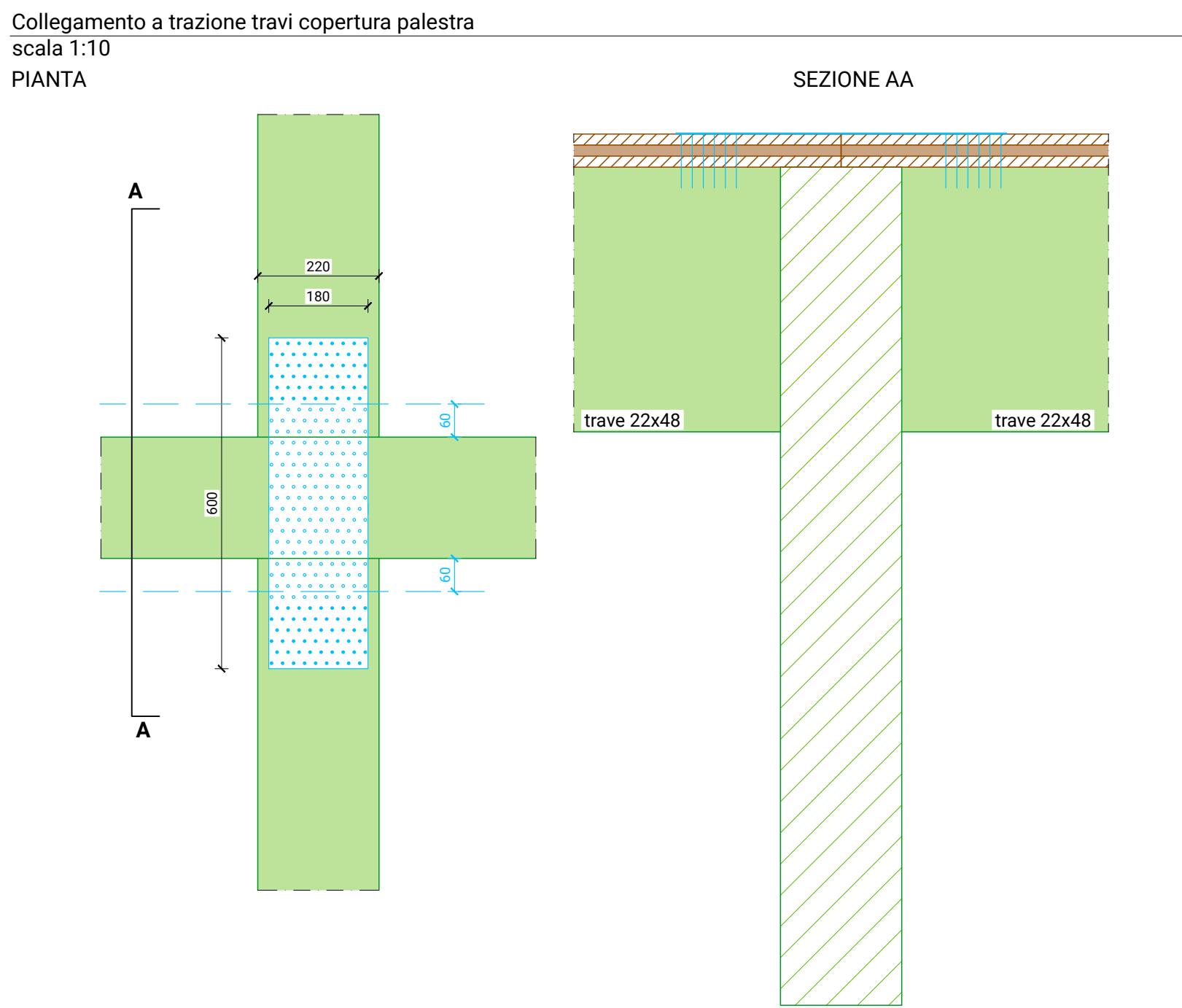
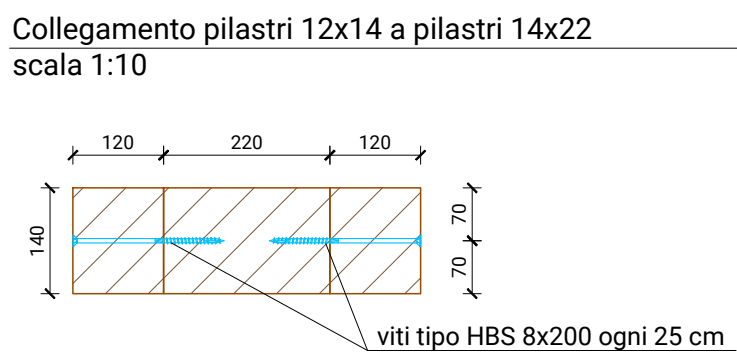
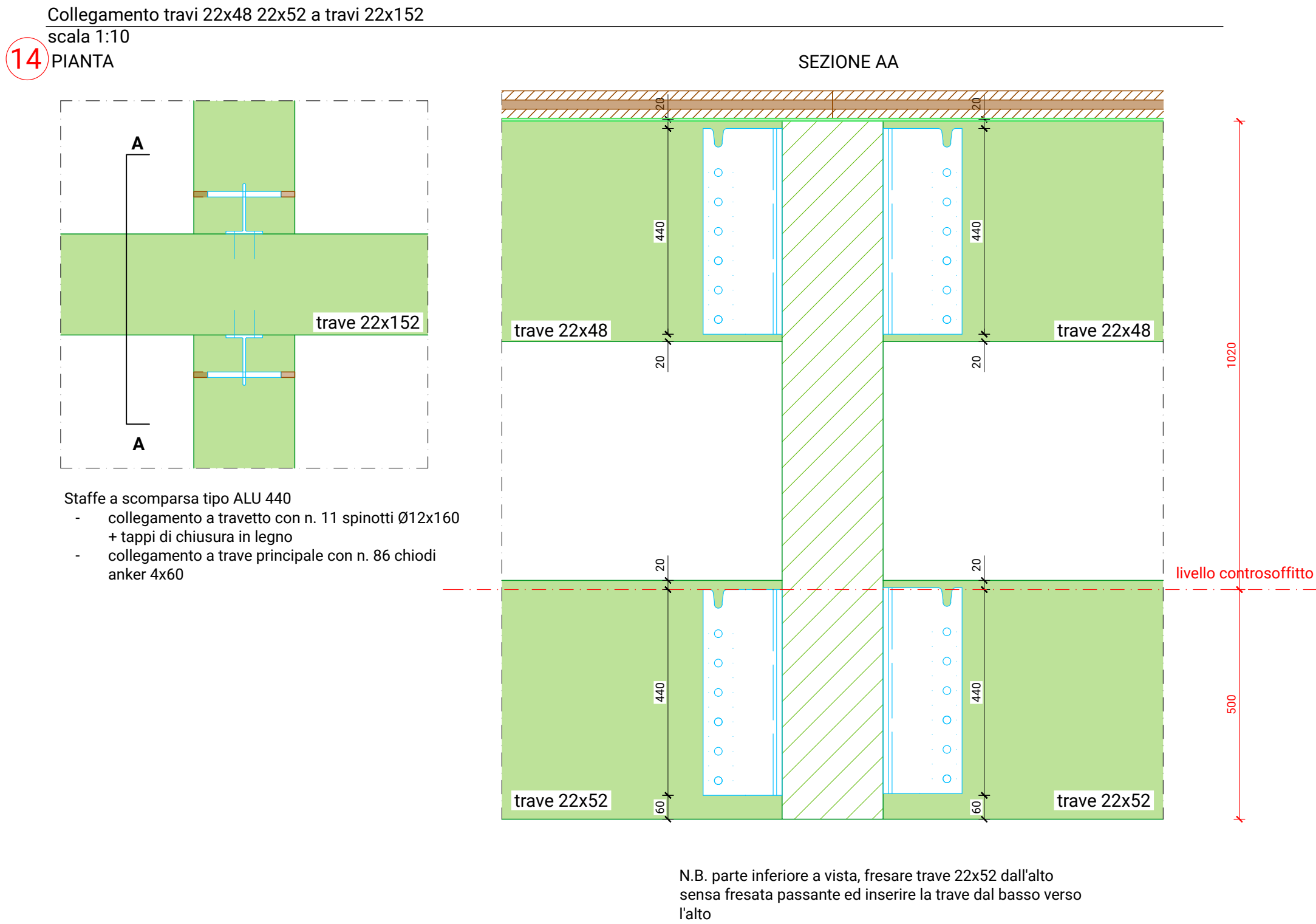
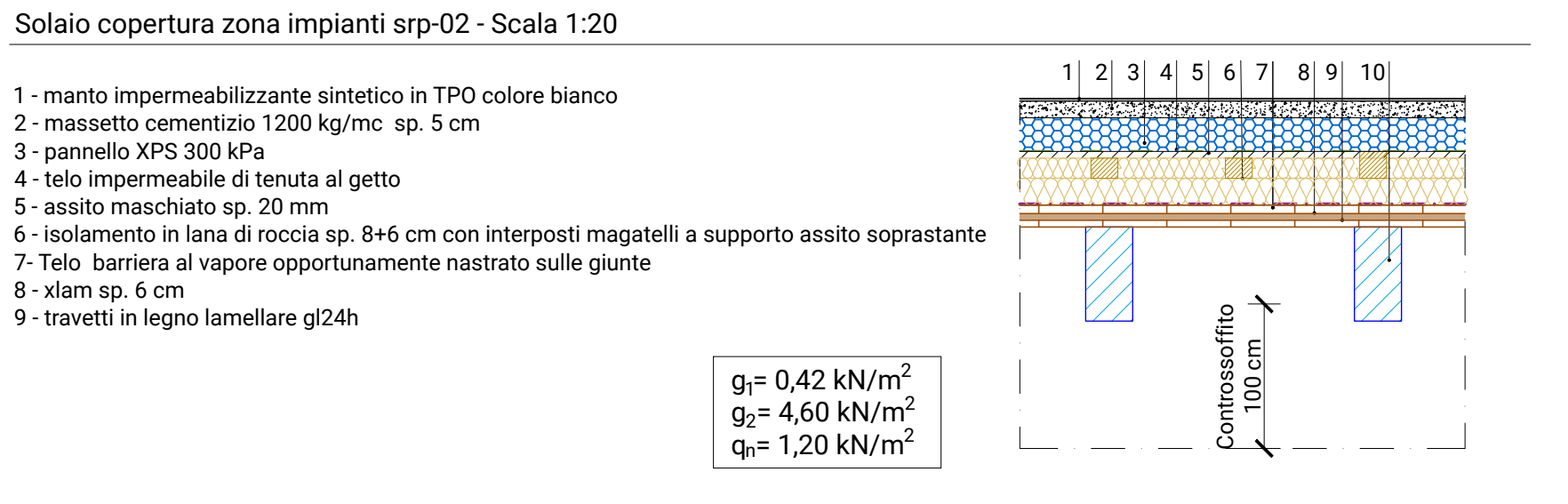
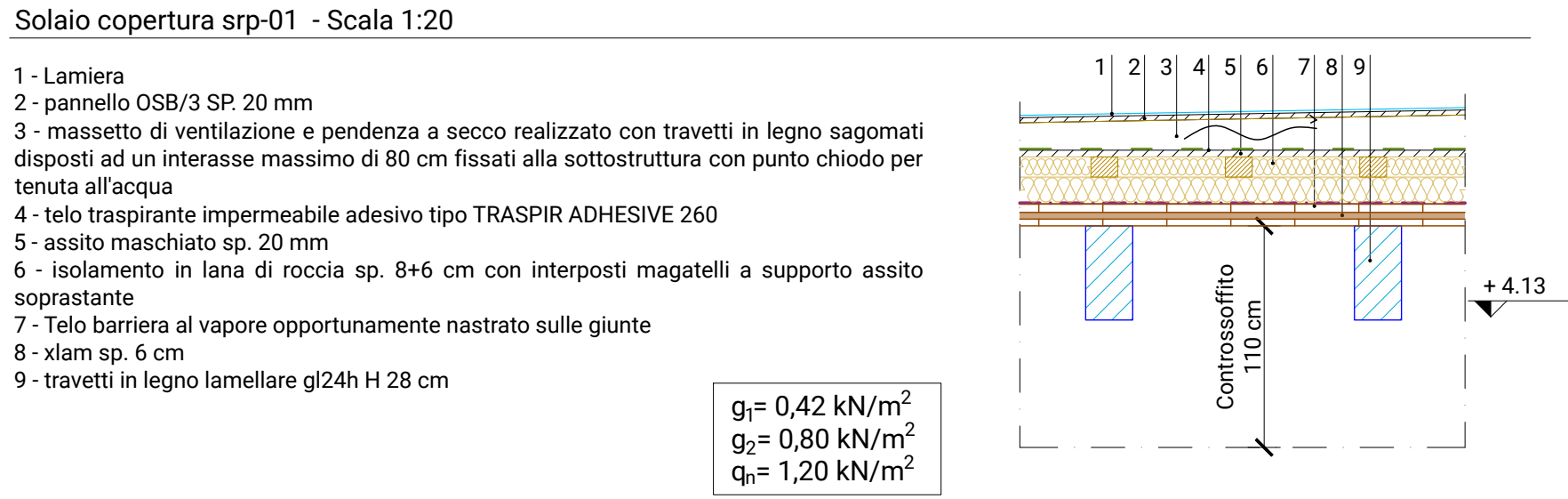
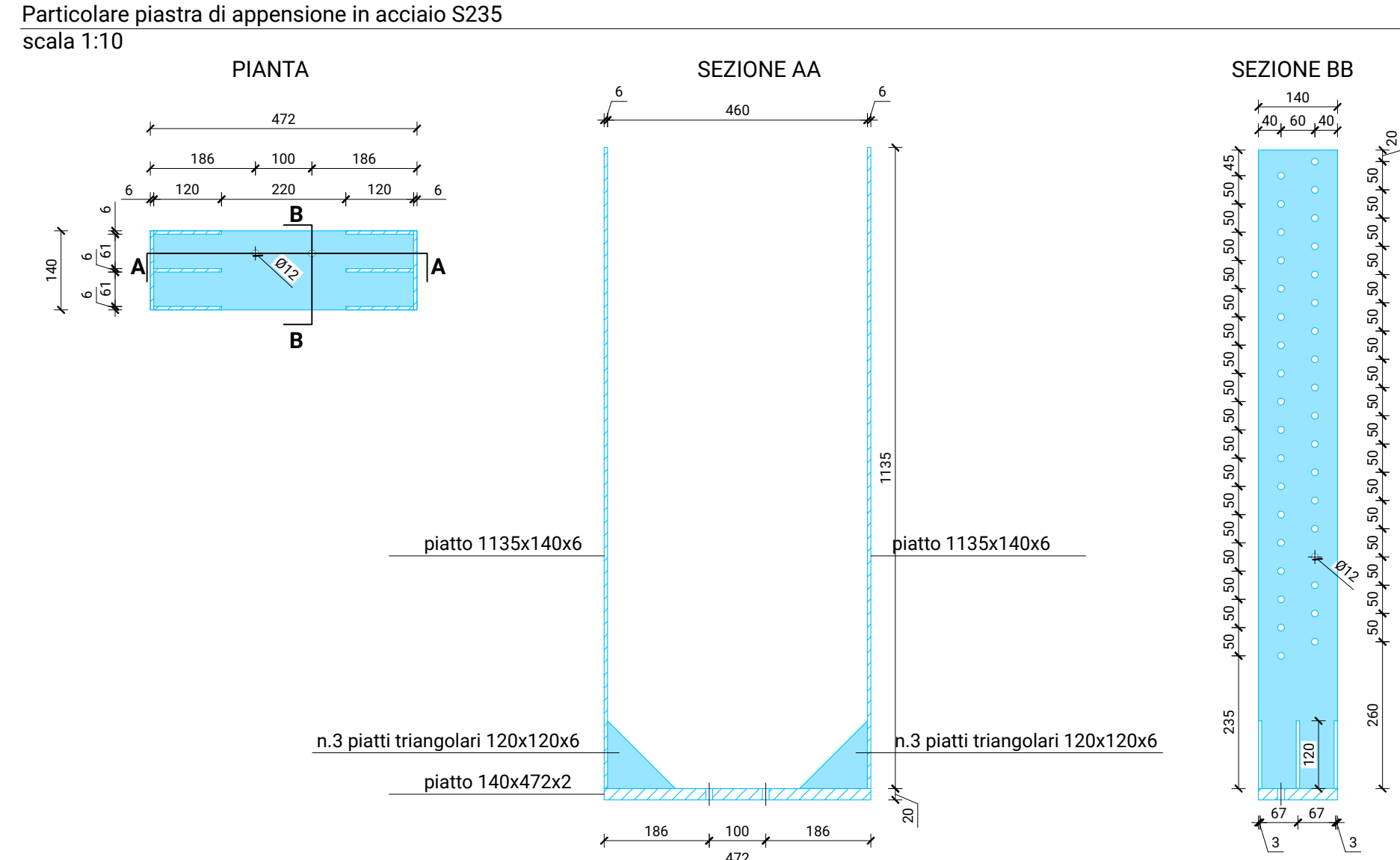
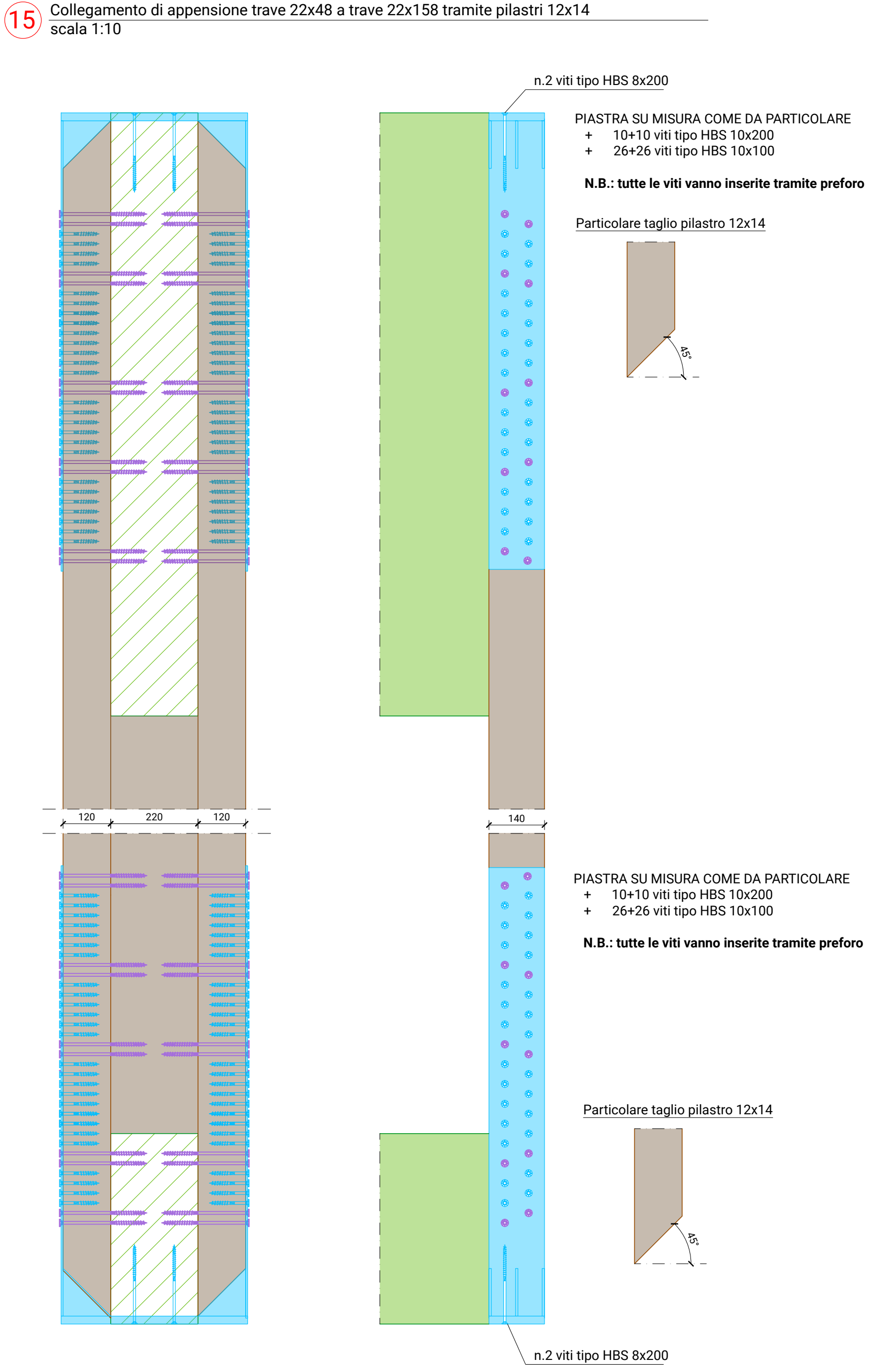
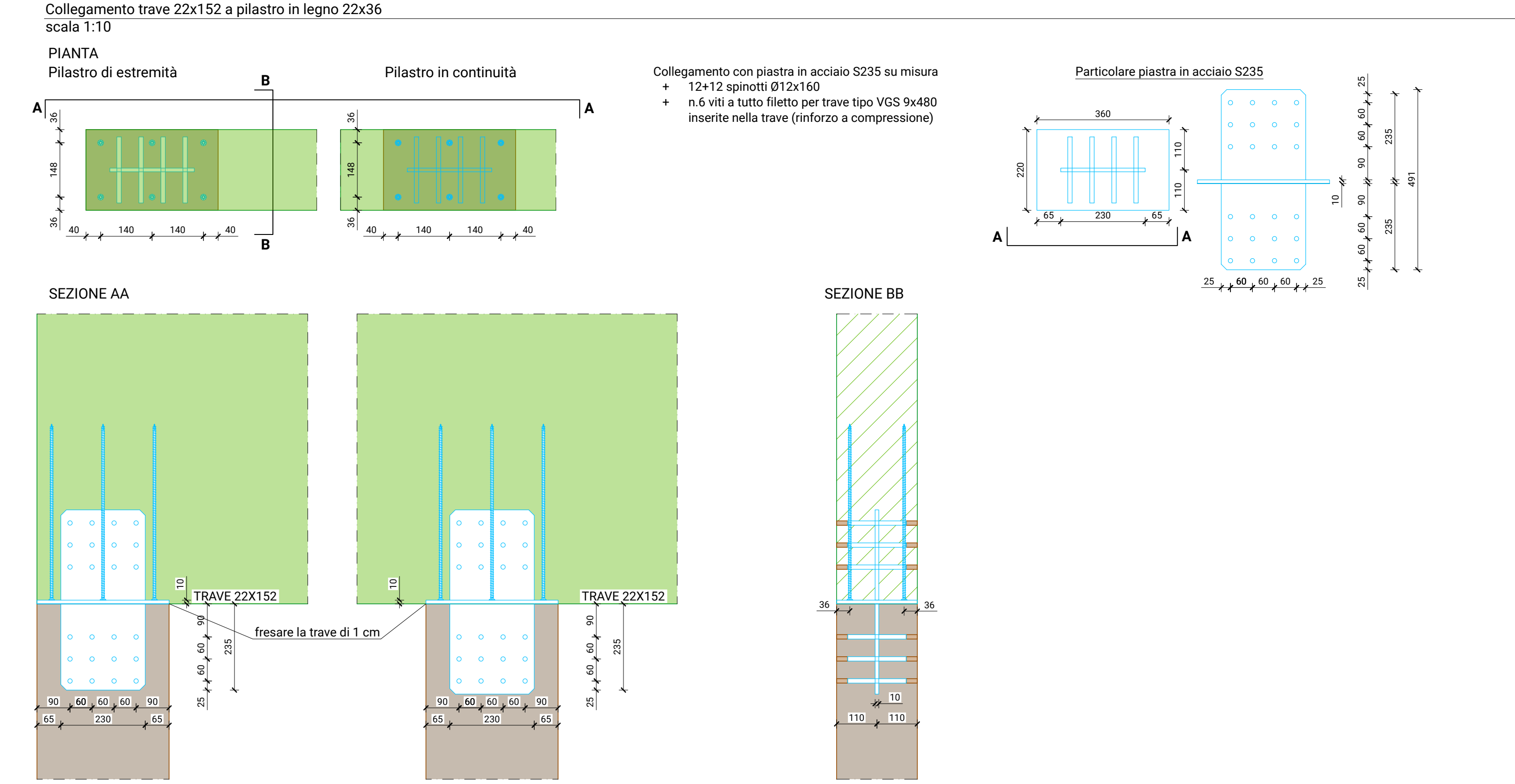




COMUNE DI Fornovo San Giovanni PROVINCIA DI BERGAMO COMMITTENTE
Nuovo Campus Scolastico con struttura sovracomunali per l'aggregazione, lo sviluppo e la socialità permanente dei minori
SCUOLA PRIMARIA E SCUOLA SECONDARIA DI PRIMO GRADO
CUP F15E2100070596
Realizzato con il contributo di REGIONE LOMBARDA
Divisione Generale Istruzione, Università, Ricerca, Innovazione e Semplificazione
UNITA' ORGANIZZATIVA EDILIZIA SCOLASTICA
ASSE I FOR FESR 2014-2020 E INTERVENTI PER LA RIPRESA ECONOMICA
PIANO LOMBARDA - BANDO "SPAZIO ALLA SCUOLA"
(Decreto n. 1705 del 21/12/2021)
RUP
Ing. Fabio Cernelli
REGIONE Lombardia
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REV. 00 Data 03/09/2024 Descrizione Prima emissione